

AM7411P-VB Datasheet P-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | |
| - 100 | 0.032 at V _{GS} = - 10 V | - 28 | 7.6 nC | | | |
| - 100 | 0.036 at V _{GS} = - 4.5 V | - 25 | 7.0110 | | | |

FEATURES

- Trench Power MOSFET
- 100 % UIS Tested

8] D

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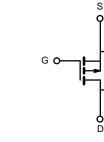
APPLICATIONS

Load Switch

Top View







P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | S (T _A = 25 °C, unle | ess otherwise n | oted) | |
|--|--|-----------------|---------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | - 100 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | | |
| | T _C = 25 °C | | - 28 ^a | |
| Continuous Drain Current (T 150 °C) | T _C = 70 °C | | - 27 | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | 22.2 ^b | А |
| | T _A = 70 °C | | - 26.1 ^b | ~ |
| Pulsed Drain Current | I _{DM} | - 15 |] | |
| Avalanche Current Pulse | L = 0.1 mH | I _{AS} | - 4.5 | |
| Single Pulse Avalanche Energy | L = 0.1 mm | E _{AS} | 10.1 | mJ |
| Continuous Source-Drain Diode Current | T _C = 25 °C | I _S | 6.9 ^a | А |
| Continuous Source-Drain Diode Current | T _A = 25 °C | 'S | 2.1 ^b | ~ |
| | T _C = 25 °C | | 10.4 ^a | |
| Maximum Power Dissipation | T _C = 70 °C | P _D | 6.6 ^a | W |
| | T _A = 25 °C | 'D | 1.1 ^b | vv |
| | T _A = 70 °C | | 2 ^b | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 33 | 40 | °C/W | | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.98 | 1.2 | C/vv | | |

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|--|-------|-------|-------|---------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \mu A$ | - 100 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μΑ | | 68 | | - mV/°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | i _D = - 250 μA | | - 5.2 | | mv/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1.8 | | - 3 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA |
| | 1 | V _{DS} = - 100 V, V _{GS} = 0 V | | | - 1 | μA |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 55 °C | | | - 10 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = -5 V, V_{GS} = -10 V$ | - 120 | | | А |
| | P | V _{GS} = - 10 V, I _D = - 3 A | | 0.032 | | Ω |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$ | | 0.036 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 5 A | 20 | | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | | | 3500 | | pF |
| Output Capacitance | C _{oss} | V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz | | 390 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 290 | | |
| Total Cata Charge | Qg | $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -5 \text{ A}$ | | 76 | 115 | nC |
| Total Gate Charge | | | | 38 | 60 | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 30 V, V_{GS} = - 4.5 V, I_D = - 5 A | | 16 | | |
| Gate-Drain Charge | Q _{gd} | | | 19 | | |
| Gate Resistance | Rg | f = 1 MHz | | 5.2 | | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | |
| Rise Time | t _r | V_{DD} = - 2 V, R_L = 2 Ω | | 7 | 15 | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 5 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 70 | 110 | |
| Fall Time | t _f | | | 40 | 60 | |
| Drain-Source Body Diode Characteristic | s | | | · | · | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | - 6.9 | A |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 15 | |
| Body Diode Voltage | V _{SD} | I _S = - 3 A | | - 1 | - 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 45 | 68 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 59 | 120 | nC |
| Reverse Recovery Fall Time | ta | I _F = - 5 A, di/dt = 10 A/μs, T _J = 25 °C | | 29 | | |
| everse Recovery Rise Time t _b | | | 16 | | ns | |

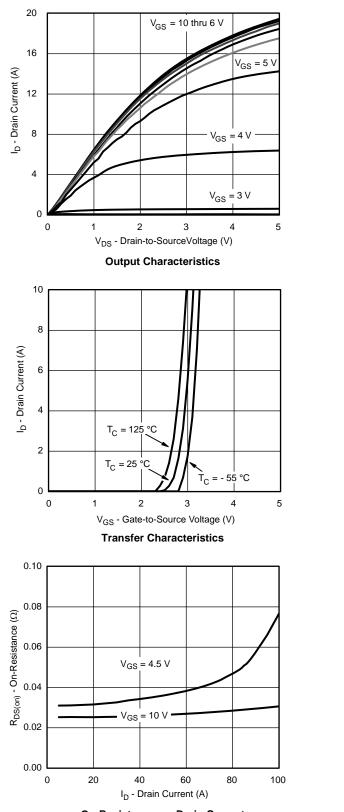
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

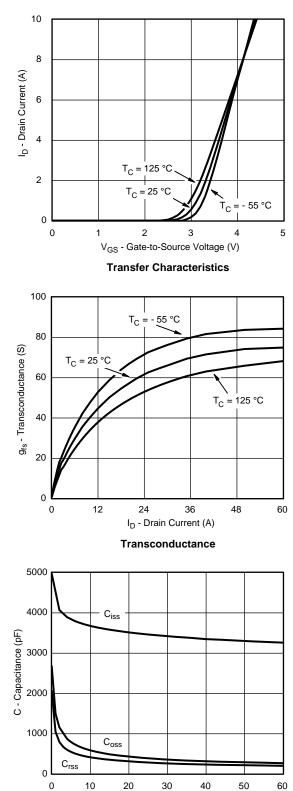




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

On-Resistance vs. Drain Current

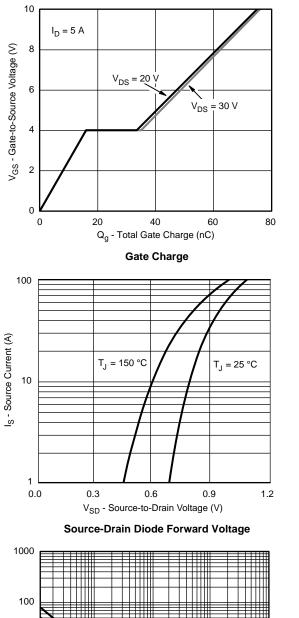
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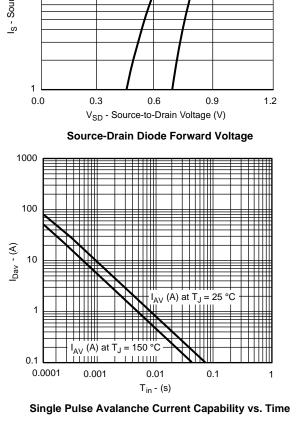
V_{DS} - Drain-to-Source Voltage (V)

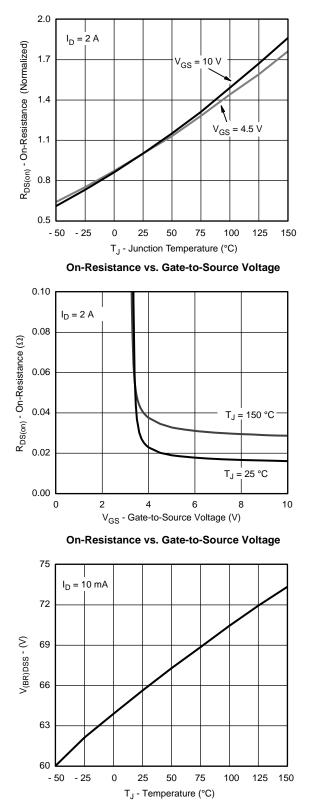
Capacitance





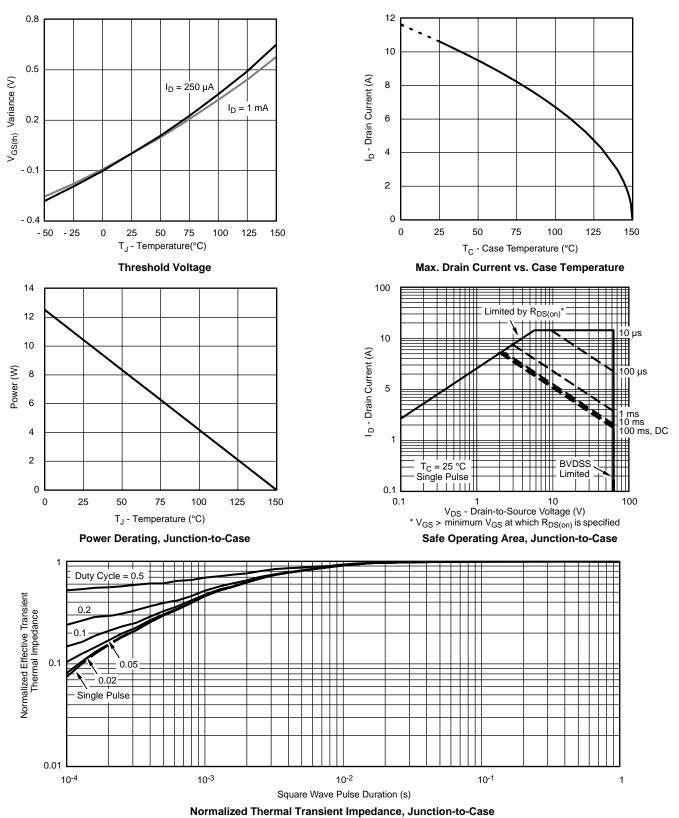
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





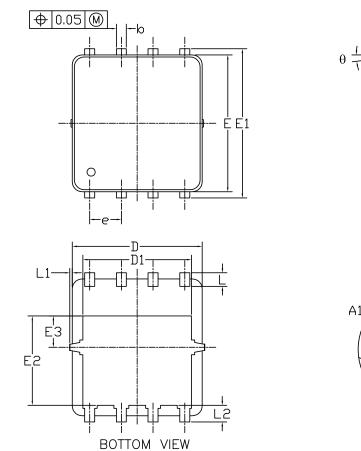
Drain-Source Breakdown Voltage vs. Junction Temperature





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





DFN5x6_8L_EP1_P PACKAGE OUTLIN

A1

Α

С

VIEW 'A'

<u>VIEW 'A'</u> (SCALE 5:1)

RECOMMENDED LAND PATTERN .60 -0.55 0.50 -0.77 -0.635 4.12 6.15 -1.60 + 0.65 +|+| + t -11.27-0.50-

| SYMBOLS | DIMENSIONS IN MILLIMETERS | | | DIMENSIONS IN INCHES | | | |
|---------|---------------------------|-------|-------|----------------------|-------|-------|--|
| SIMBOLS | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.85 | 0.95 | 1.00 | 0.033 | 0.037 | 0.039 | |
| A1 | 0.00 | | 0.05 | 0.000 | | 0.002 | |
| b | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 | |
| с | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | 5.10 | 5.20 | 5.30 | 0.201 | 0.205 | 0.209 | |
| D1 | 4.25 | 4.35 | 4.45 | 0.167 | 0.171 | 0.175 | |
| E | 5.45 | 5.55 | 5.65 | 0.215 | 0.219 | 0.222 | |
| E1 | 5.95 | 6.05 | 6.15 | 0.234 | 0.238 | 0.242 | |
| E2 | 3.525 | 3.625 | 3.725 | 0.139 | 0.143 | 0.147 | |
| E3 | 1.175 | 1.275 | 1.375 | 0.046 | 0.050 | 0.054 | |
| e | 1.27 BSC | | | 0.050 BSC | | | |
| L | 0.45 | 0.55 | 0.65 | 0.018 | 0.022 | 0.026 | |
| L1 | 0 | | 0.15 | 0 | | 0.006 | |
| L2 | 0.68 REF | | | 0.027 REF | | | |
| θ | 0° | | 10° | 0° | | 10° | |

UNIT: mm

NOTE 1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH. 2. CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.



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